- Package Options Include Plastic "Small Outline" Packages, Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

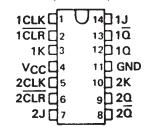
description

The '73, and 'H73, contain two independent J-K flip-flops with individual J-K, clock, and direct clear inputs. The '73, and 'H73, are positive pulse-triggered flip-flops. J-K input is loaded into the master while the clock is high and transferred to the slave on the high-to-low transition. For these devices the J and K inputs must be stable while the clock is high.

The 'LS73A contains two independent negative-edge-triggered flip-flops. The J and K inputs must be stable one setup time prior to the high-to-low clock transition for predictable operation. When the clear is low, it overrides the clock and data inputs forcing the Ω output low and the $\overline{\Omega}$ output high.

The SN5473, SN54H73, and the SN54LS73A are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7473, and the SN74LS73A are characterized for operation from 0 °C to 70 °C.

SN5473, SN54LS73A . . . J OR W PACKAGE SN7473 . . . N PACKAGE SN74LS73A . . . D OR N PACKAGE (TOP VIEW)



73
FUNCTION TABLE

	INPUT	OUT	PUTS		
CLR	CLK	J	K	Q	ā
L	×	Х	Х	L	Н
Н	Ţ	L	L	00	\bar{a}_0
H	九	Н	L	Н	L
Н	ъ.	L	Н	L	Н
Н	л	Н	Н	TOG	GLE

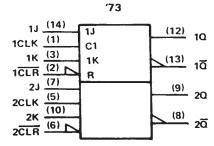
'L\$73A FUNCTION TABLE

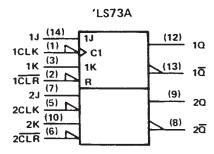
	INPUT	OUTP	UTS		
CLR	CLK	J	K	Q	₫
L	X	Х	Х	L	Н
н	1	L	L	αo	\overline{a}_{O}
н	1	Н	L	Н	L
н	1	L	Н	L	н
н	4	Н	Н	TOG	GLE
н	Н	Х	Х	αo	\bar{a}_0

FOR CHIP CARRIER INFORMATION.
CONTACT THE FACTORY



logic symbols†



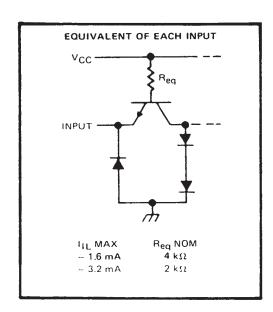


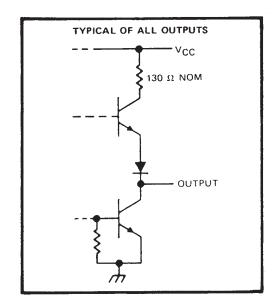
[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

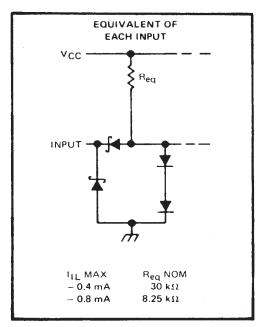
′73

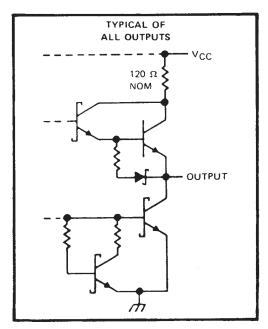
'LS73

schematics of inputs and outputs

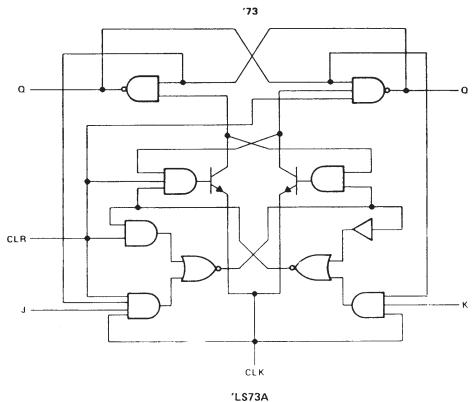


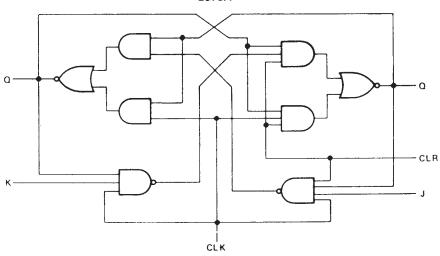






logic diagrams (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (See Note 1)	7 V
Input voltage: '73	5.5 V
LS73A	7 V
Operating free-air temperature range:	SN54'
opolating tree on temperature tanget	SN74' 0° C to 70°C
	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



SN5473, SN54LS73A, SN7473, SN74LS73A DUAL J-K FLIP-FLOPS WITH CLEAR

SDLS118 - DECEMBER 1983 - REVISED MARCH 1988

recommended operating conditions

			SN5473				UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage		2			2			٧
VIL	Low-level input voltage				0.8			0.8	٧
ЮН	High-level output current			-0.4			- 0.4	mA	
loL	Low-level output current				16			16	mA
		CLK high	20			20			
tw	Pulse duration	CLK low	47			47			ns
		ČLR low				25			_
t _{su}	Input setup time before CLK t		0			0			ns
th	Input hold time data after CLK↓		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†			SN5473			SN7473		UNIT	
PA	RAMEIER	11	EST CONDITION	181	MIN	TYP\$	MAX	MIN	TYP‡	MAX	UNIT
VIK		V _{CC} = MIN,	I _I = - 12 mA				- 1.5			- 1.5	V
Vон		V _{CC} = MIN, I _{OH} = - 0.4 mA	V _{IH} = 2 V,	V _{IL} = 0.8 V,	2.4	3.4		2.4	3.4		٧
VOL		V _{CC} = MIN, I _{OL} = 16 mA	V _{IH} = 2 V,	V _{IL} = 0.8 V,		0.2	0.4		0.2	0.4	v
11		V _{CC} = MAX,	V _I = 5.5 V				1			1	mA
ЧН	J or K	V _{CC} = MAX,	V ₁ = 2.4 V				40 80			40 80	μА
	J or K						- 1.6			- 1.6	
ItL	CLR	V _{CC} = MAX,	V ₁ = 0.4 V				- 3,2			- 3.2	mA
	CLK		·				- 3.2			- 3.2]
los§		V _{CC} = MAX			- 20		– 57	- 18		- 57	mA
Icc1		V _{CC} = MAX,	See Note 2			10	20	<u> </u>	10	20	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open, I_{CC} is measured with the Q and \overline{Q} outputs high in turn. At the time of measurement, the clock input is grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}				15	20		MHz
^t PLH	CLR	₫.			16	25	ns
^t PHL	CLA	Q	$R_{L} = 400 \Omega$, $C_{L} = 15 p$	F	25	40	กร
^t PLH	CLK	Q or Q			16	25	ns
^t PHL	CLN	2 07 02			25	40	ns

[#]f_{max} = maximum clock frequency: tp_{LH} = propagation delay time, low-to-high-level output; tp_{HL} = propagation delay time, high-to-low-level output.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at VCC = 5 V, TA = 25 °C.

[§] Not more than one output should be shorted at a time.

[¶] Average per flip-flop.

recommended operating conditions

			SI	N54LS7	3A	Si			
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
ViH	High-level input voltage		2			2			٧
VIL	Low-level input voltage			0.7			0.8	V	
Іон	High-level output current				- 0.4			- 0.4	mA
lOL	Low-level output current			4			8	mA	
fclock	Clock frequency		0		30	0		30	MHz
	Pulse duration	CLK high	20			20			
t _W	ruise duration	CLR low	25			20			กร
	Con an almost had not Ol 161	data high or low	20			20			
t _{su}	Set up time-before CLK↓ CLR inactive					20			ns
th	Hold time-data after CLK↓		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	RAMETER		ST CONDITION	et	SI	N54LS7:	3A	SI	UNIT		
FA	MAMEIEN	TEST CONDITIONS		MIN	TYP#	MAX	MIN	TYP‡	MAX	UNIT	
VIK		V _{CC} = MIN,	$t_1 = -18 \text{ mA}$				- 1.5			- 1.5	٧
VOH		V _{CC} = MIN, I _{OH} = - 0.4 mA	V _{IH} = 2 V,	V _{IL} = MAX,	2.5	3.4		2.7	3.4		٧
)/	1 lo: = 4 mA		0.25	0.4		0.25	0.4	V			
VOL		V _{CC} = MIN, I _{OL} = 8 mA	VIL = MAX,	V _{IH} = 2 V,					0.35	0.5	
	J or K						0.1			0.1	
lų –	CLR	V _{CC} = MAX,	V! = 7 V	_! = 7 V						0.3	mA
	CLK						0.4			0.4	
	J or K						20			20	
ЧН	CLR	V _{CC} = MAX,	V _I = 2.7 V				60			60_	μА
	CLK						80			80]
,	J or K	1/ - A4 A V					0.4			- 0,4	_^
IL	CLR or CLK	V _{CC} = MAX,	V ₁ = 0.4 V				- 0.8			- 0.8	mA
los\$		V _{CC} = MAX,	See Note 4		- 20		– 100	- 20		- 100	mA
ICC (T	otal)	V _{CC} = MAX,	See Note 2			4	6		4	6	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	мах	UNIT
f _{max}				30	45		MHz
tPLH	CI B or CI K	Q or Q	$R_{\perp} = 2 k\Omega$, $C_{\perp} = 15$	i pF	15	20	ns
tPHL	CLR or CLK	Q or Q			15	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: With all outputs open, I_{CC} is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded.

NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

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